onsemi

BCW30LT1G, SBCW30LT1G General Purpose Transistors

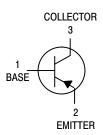
PNP Silicon

Features

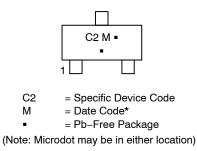
- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant



SOT-23 (TO-236) CASE 318-08 STYLE 6



MARKING DIAGRAM



*Date Code orientation and/or overbar may vary depending upon manufacturing location.

ORDERING INFORMATION

| Device | Package | Shipping |
|------------|---------------------|-------------------|
| BCW30LT1G | SOT-23 (Pb-Free) | 3,000/Tape & Reel |
| SBCW30LT1G | SOT-23 (Pb-Free) | 3,000/Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--------------------------------|------------------|-------|------|
| Collector – Emitter Voltage | V _{CEO} | -32 | Vdc |
| Collector – Base Voltage | V _{CBO} | -32 | Vdc |
| Emitter-Base Voltage | V _{EBO} | -5.0 | Vdc |
| Collector Current – Continuous | Ι _C | -100 | mAdc |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|--|-----------------------------------|-------------|-------------|
| Total Device Dissipation FR-5 Board (Note 1) $T_A = 25^{\circ}C$ Derate above $25^{\circ}C$ | P _D | 225 1.8 | mW mW/°C |
| Thermal Resistance, Junction-to-Ambient | R _{θJA} | 556 | °C/W |
| Total Device Dissipation Alumina Substrate (Note 2) T _A = 25°C Derate above 25°C | PD | 300 2.4 | mW mW/°C |
| Thermal Resistance, Junction-to-Ambient | R _{θJA} | 417 | °C/W |
| Junction and Storage Temperature | T _J , T _{stg} | –55 to +150 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. FR-5 = 1.0 \times 0.75 \times 0.062 in.

2. Alumina = 0.4 \times 0.3 \times 0.024 in. 99.5% alumina.

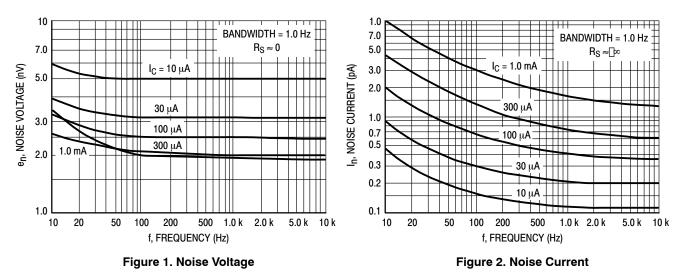
ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

| Characteristic | Symbol | Min | Max | Unit |
|---|----------------------|------|-------------|--------------|
| DFF CHARACTERISTICS | | | | |
| Collector–Emitter Breakdown Voltage $(I_{C} = -2.0 \text{ mAdc}, I_{E} = 0)$ | V _{(BR)CEO} | -32 | _ | Vdc |
| Collector–Emitter Breakdown Voltage ($I_C = -100 \ \mu Adc$, $V_{EB} = 0$) | V _{(BR)CES} | -32 | - | Vdc |
| Collector–Base Breakdown Voltage $(I_C = -10 \ \mu Adc, I_C = 0)$ | V _{(BR)CBO} | -32 | _ | Vdc |
| Emitter–Base Breakdown Voltage $(I_E = -10 \ \mu Adc, I_C = 0)$ | V _{(BR)EBO} | -5.0 | _ | Vdc |
| Collector Cutoff Current ($V_{CB} = -32$ Vdc, $I_E = 0$) ($V_{CB} = -32$ Vdc, $I_E = 0$, $T_A = 100^{\circ}$ C) | Ісво | - | -100 -10 | nAdc μAdc |
| ON CHARACTERISTICS | | | | |
| DC Current Gain (I _C = -2.0 mAdc, V _{CE} = -5.0 Vdc) | h _{FE} | 215 | 500 | - |
| Collector–Emitter Saturation Voltage ($I_C = -10$ mAdc, $I_B = -0.5$ mAdc) | V _{CE(sat)} | _ | -0.3 | Vdc |
| Base-Emitter On Voltage ($I_C = -2.0$ mAdc, $V_{CE} = -5.0$ Vdc) | V _{BE(on)} | -0.6 | -0.75 | Vdc |
| SMALL-SIGNAL CHARACTERISTICS | | | • | • |
| Output Capacitance ($I_E = 0$, $V_{CB} = -10$ Vdc, f = 1.0 MHz) | C _{obo} | _ | 7.0 | pF |
| Noise Figure (I _C = -0.2 mAdc, V _{CE} = -5.0 Vdc, R _S = 2.0 k Ω , f = 1.0 kHz, BW = 200 H | NF Iz) | _ | 10 | dB |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL NOISE CHARACTERISTICS

 $(V_{CE} = -5.0 \text{ Vdc}, \text{ T}_{A} = 25^{\circ}\text{C})$



NOISE FIGURE CONTOURS

 $(V_{CE}=-5.0~Vdc,~T_{A}=25^{\circ}C)$

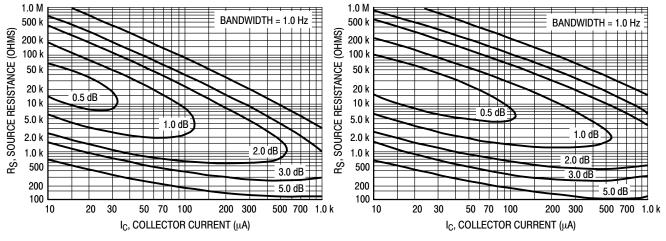


Figure 3. Narrow Band, 100 Hz



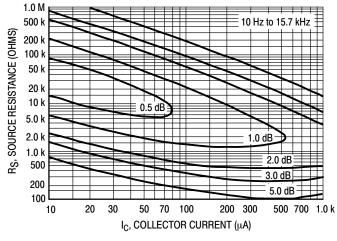


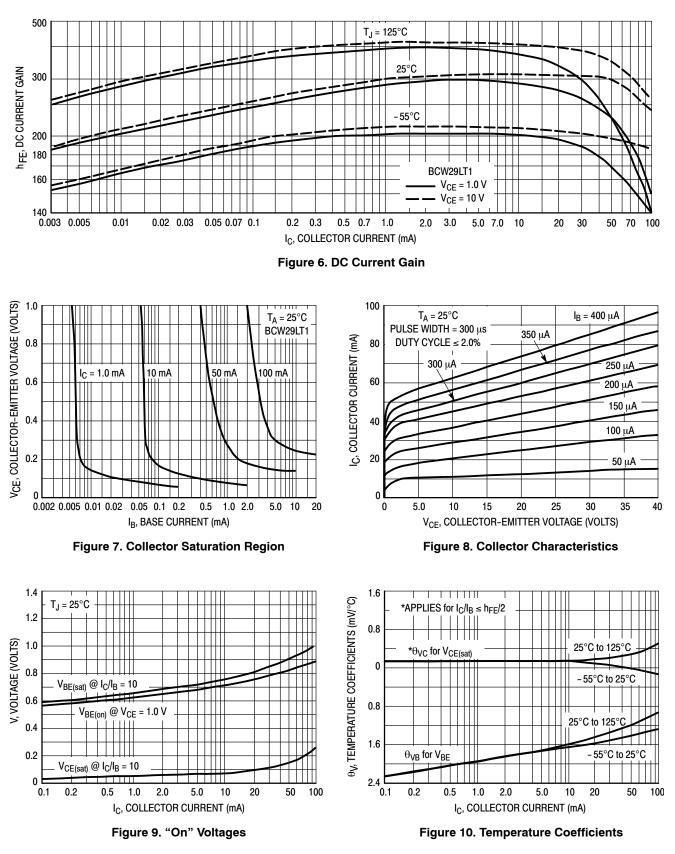
Figure 5. Wideband

Noise Figure is Defined as:

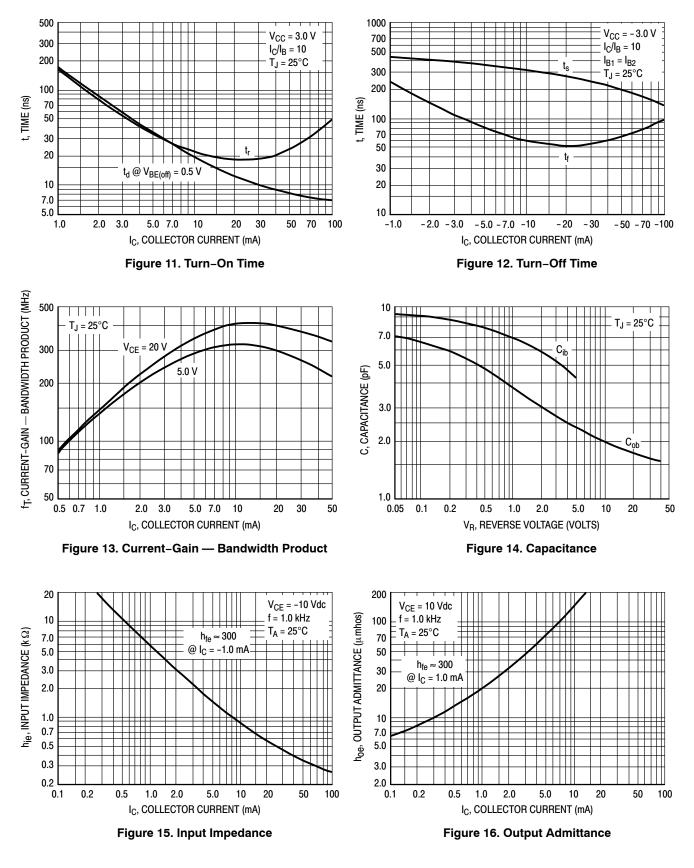
NF = 20 log₁₀
$$\left[\frac{e_{n}^{2} + 4KTR_{S} + I_{n}^{2}R_{S}^{2}}{4KTR_{S}} \right]^{1/2}$$

- e_n = Noise Voltage of the Transistor referred to the input. (Figure 3)
- I_n = Noise Current of the Transistor referred to the input. (Figure 4)
- K = Boltzman's Constant (1.38 x 10^{-23} j/°K)
- T = Temperature of the Source Resistance (°K)
- R_S = Source Resistance (Ohms)

TYPICAL STATIC CHARACTERISTICS



TYPICAL DYNAMIC CHARACTERISTICS



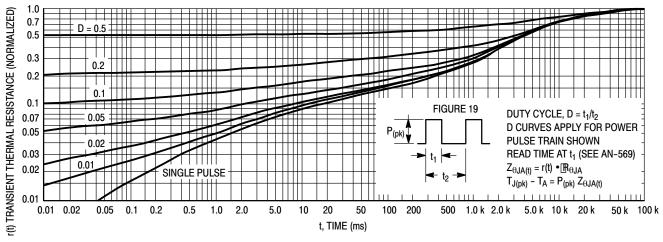


Figure 17. Thermal Response

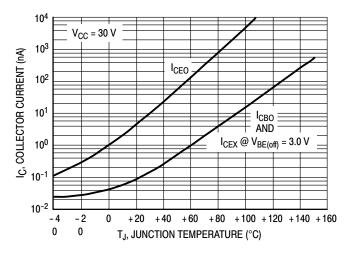


Figure 18. Typical Collector Leakage Current

DESIGN NOTE: USE OF THERMAL RESPONSE DATA

A train of periodical power pulses can be represented by the model as shown in Figure 19. Using the model and the device thermal response the normalized effective transient thermal resistance of Figure 17 was calculated for various duty cycles.

To find $Z_{\theta JA(t)},$ multiply the value obtained from Figure 17 by the steady state value $R_{\theta JA}.$

Example:

The BCW29LT1 is dissipating 2.0 watts peak under the following conditions:

Using Figure 17 at a pulse width of 1.0 ms and D = 0.2, the reading of r(t) is 0.22.

The peak rise in junction temperature is therefore

 $\Delta T = r(t) \times P_{(pk)} \times R_{\theta JA} = 0.22 \times 2.0 \times 200 = 88^{\circ}C.$

For more information, see AN-569.

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SOT-23 (TO-236) 2.90x1.30x1.00 1.90P **CASE 318**

ISSUE AU

DATE 14 AUG 2024













XXX = Specific Device Code М = Date Code

= Pb-Free Package .

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



| MILLIMETERS | | | | | |
|-------------|------|------|------|--|--|
| DIM | MIN | NOM | МАХ | | |
| А | 0.89 | 1.00 | 1.11 | | |
| A1 | 0.01 | 0.06 | 0.10 | | |
| b | 0.37 | 0.44 | 0.50 | | |
| с | 0.08 | 0.14 | 0.20 | | |
| D | 2.80 | 2.90 | 3.04 | | |
| E | 1.20 | 1.30 | 1.40 | | |
| е | 1.78 | 1.90 | 2.04 | | |
| L | 0.30 | 0.43 | 0.55 | | |
| L1 | 0.35 | 0.54 | 0.69 | | |
| Ηe | 2.10 | 2.40 | 2.64 | | |
| Т | 0° | | 10° | | |

NOTES:

DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018. CONTROLLING DIMENSIONS: 1.

2. MILLIMETERS.

MILLIME IERS. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE 3.

BASE MATERIAL. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, 4. PROTRUSIONS, OR GATE BURRS.

RECOMMENDED MOUNTING FOOTPRINT

* For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

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SOT-23 (TO-236) 2.90x1.30x1.00 1.90P **CÁSE 318** ISSUE AU

DATE 14 AUG 2024

| STYLE 1 THRU 5: CANCELLED | STYLE 6: PIN 1. BASE 2. EMITTER 3. COLLECTOR | STYLE 7: PIN 1. EMITTER 2. BASE 3. COLLECTOR | STYLE 8: PIN 1. ANODE 2. NO CONNECTION 3. CATHODE | I | |
|---|---|---|--|------------------|------------------|
| STYLE 9: | STYLE 10: | STYLE 11: | STYLE 12: | STYLE 13: | STYLE 14: |
| PIN 1. ANODE | PIN 1. DRAIN | PIN 1. ANODE | PIN 1. CATHODE | PIN 1. SOURCE | PIN 1. CATHODE |
| 2. ANODE | 2. SOURCE | 2. CATHODE | 2. CATHODE | 2. DRAIN | 2. GATE |
| 3. CATHODE | 3. GATE | 3. CATHODE-ANODE | 3. ANODE | 3. GATE | 3. ANODE |
| STYLE 15: | STYLE 16: | STYLE 17: | STYLE 18: | STYLE 19: | STYLE 20: |
| PIN 1. GATE | PIN 1. ANODE | PIN 1. NO CONNECTION | PIN 1. NO CONNECTION | I PIN 1. CATHODE | PIN 1. CATHODE |
| 2. CATHODE | 2. CATHODE | 2. ANODE | 2. CATHODE | 2. ANODE | 2. ANODE |
| 3. ANODE | 3. CATHODE | 3. CATHODE | 3. ANODE | 3. CATHODE-ANODE | 3. GATE |
| STYLE 21: | STYLE 22: | STYLE 23: | STYLE 24: | STYLE 25: | STYLE 26: |
| PIN 1. GATE | PIN 1. RETURN | PIN 1. ANODE | PIN 1. GATE | PIN 1. ANODE | PIN 1. CATHODE |
| 2. SOURCE | 2. OUTPUT | 2. ANODE | 2. DRAIN | 2. CATHODE | 2. ANODE |
| 3. DRAIN | 3. INPUT | 3. CATHODE | 3. SOURCE | 3. GATE | 3. NO CONNECTION |
| STYLE 27: PIN 1. CATHODE 2. CATHODE 3. CATHODE | STYLE 28: PIN 1. ANODE 2. ANODE 3. ANODE | | | | |

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